

N-Ch 100V Fast Switching MOSFET $V_{DS}=100V$, $I_{D}=78A$, $RDS_{(ON)}=8.0m\Omega$

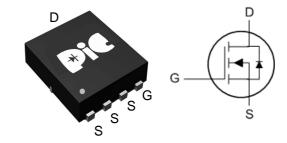
General Description

This PANO0SY48Y N-Channel enhancement mode power field effect transistor is the high density trench technology and this advanced technology can provide excellent Rds(On) performance and efficiency for power switching and load switching application., this device also comply with the RoHS and Green Product requirement with full function reliability approved.

> Feature

- Super Low Gate Charge
- ●100% EAS Guaranteed
- •Green Device Available
- ●Excellent CdV/dt effect decline
- Advanced high cell density Trench technology

DFN5X6A-EP1



> Application

- ●DC/DC Primary Side Switch
- Industrial Synchronous
- Rectification Load Switch
- ●DC/DC Converters

> Absolute Maximum Ratings

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _G s	±20	V
Continuous Drain Current ^{1,6}	I _D @T _C =25°C	78	Α
Continuous Drain Current ^{1,6}	I _D @T _C =70°C	62	А
Pulsed Drain Current ²	I _{DM}	280	А
Single Pulse Avalanche Energy ³	EAS	EAS 26.5	
Avalanche Current	IAS	23	А
Total Power Dissipation ⁴	P _D @T _C =25°C	108	W
Storage Temperature Range	T _{STG}	-55 to 150	$^{\circ}\mathbb{C}$
Operating Junction Temperature Range	TJ	-55 to 150	$^{\circ}\mathbb{C}$
Thermal Resistance Junction-Ambient ¹(t≤10s)	Reja	25	°C/W
Thermal Resistance Junction-Ambient ¹	T θJA	55	°C/W
Thermal Resistance Junction-Case ¹	Reлc	1.3	°C/W



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Electrical Characteristics (T_J=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V , I _D =250uA	100			V	
Static Drain-Source On-Resistance ²	Dagger	V _{GS} =10V , I _D =13.5A		6.6	8	mΩ	
Static Drain-Source On-Resistance ² R _{DS(ON)} V _{GS} =4.5V , I _D =11.		V _{GS} =4.5V , I _D =11.5A		8.7	10.5	1115.2	
Gate Threshold Voltage	V _{GS(th)}	V _{GS} =V _{DS} , I _D =250uA	1.2		2.3	V	
Drain Source Leakage Current	lana	V _{DS} =80V , V _{GS} =0V , T _J =25°C	80V , V _{GS} =0V , T _J =25°C		1		
Drain-Source Leakage Current	I _{DSS}	$V_{DS}=80V$, $V_{GS}=0V$, $T_{J}=55^{\circ}C$			5	uA	
Gate-Source Leakage Current	Igss	V _{GS} =±20V , V _{DS} =0V			±100	nA	
Forward Transconductance	gfs	V _{DS} =5V , I _D =20A		85		S	
Total Gate Charge (10V)	Qg			45			
Total Gate Charge (4.5V)	Qg	VD0 F0V V00 10V ID 12 FA		19.3		~C	
Gate-Source Charge	Qgs	VDS=50V , VGS=10V , ID=13.5A		9.5		nC	
Gate-Drain Charge	Qgd			4.8			
Turn-On Delay Time	Td(on)			10			
Rise Time	Tr	VDD=50V , VGS=10V , RG=3 Ω ,		6.5		20	
Turn-Off Delay Time	Td(off)	ID=13.5A		45		ns	
Fall Time	Tf			7.5			
Input Capacitance	Ciss			3320			
Output Capacitance	Coss	VDS=50V , VGS=0V , f=1MHz		605		pF	
Reverse Transfer Capacitance	Crss			20			

Diode Characteristics

Parameter	Symbol	nbol Conditions		Тур.	Max.	Unit
Continuous Source Current ^{1,5,6}	Is	V _G =V _D =0V , Force Current		-	45	Α
Diode Forward Voltage ²	V_{SD}	V_{GS} =0 V , I_{S} =1 A , T_{J} =25 $^{\circ}$ C			1.1	٧
Reverse Recovery Time	t _{rr}	IF=13.5A , di/dt=100A/µs ,		33		nS
Reverse Recovery Charge	Qrr	TJ=25°C		150		nC

Note:

^{1.} Pulse width limited by maximum junction temperature.

^{2.}The data tested by pulsed , pulse width ≦ 300us , duty cycle ≦ 2%

^{3.} The EAS data shows Max. rating . The test condition is V_{DD} =50V, V_{GS} =10V, L=0.1mH, I_{AS} =23A

^{4.} The power dissipation is limited by 150°C junction temperature

^{5.} The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

^{6.} The maximum current rating is package limited.



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> Typical Characteristics

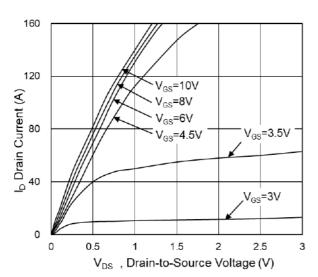


Fig.1 Typical Output Characteristics

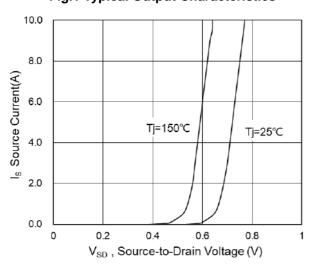


Fig.3 Source-Drain Forward Characteristics

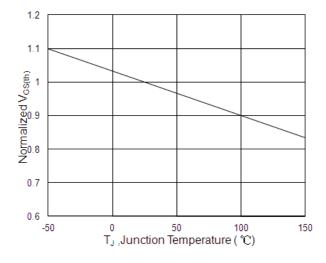


Fig.5 Normalized $V_{\text{GS(th)}}$ vs T_{J}

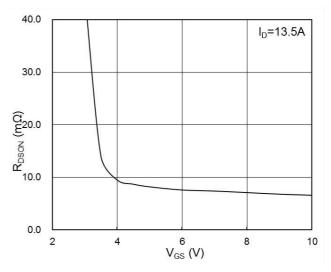


Fig.2 On-Resistance vs G-S Voltage

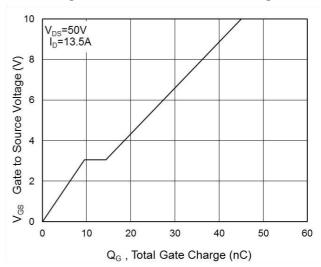


Fig.4 Gate-Charge Characteristics

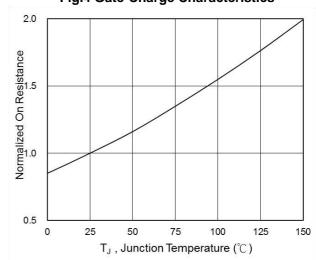
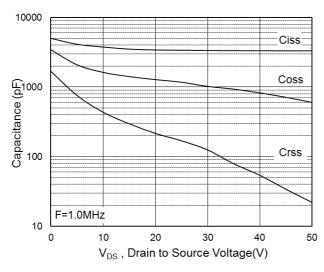


Fig.6 Normalized R_{DSON} vs T_J



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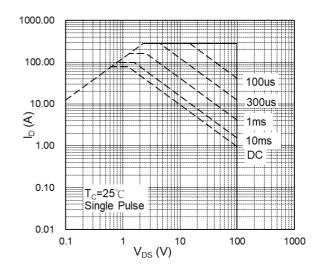


Fig.7 Capacitance

Fig.8 Safe Operating Area

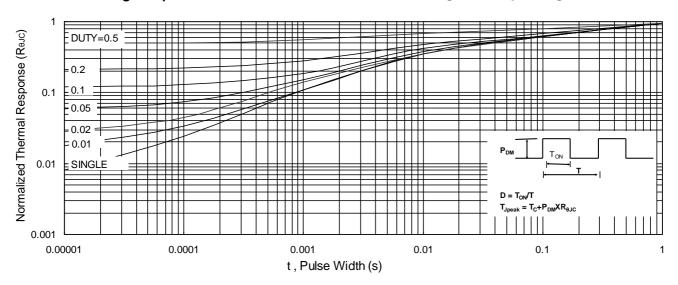


Fig.9 Normalized Maximum Transient Thermal Impedance

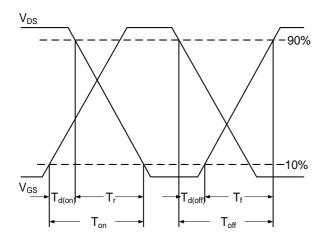


Fig.10 Switching Time Waveform

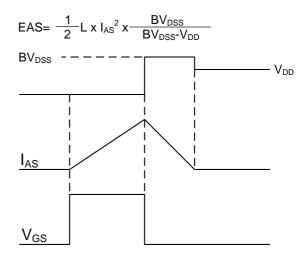
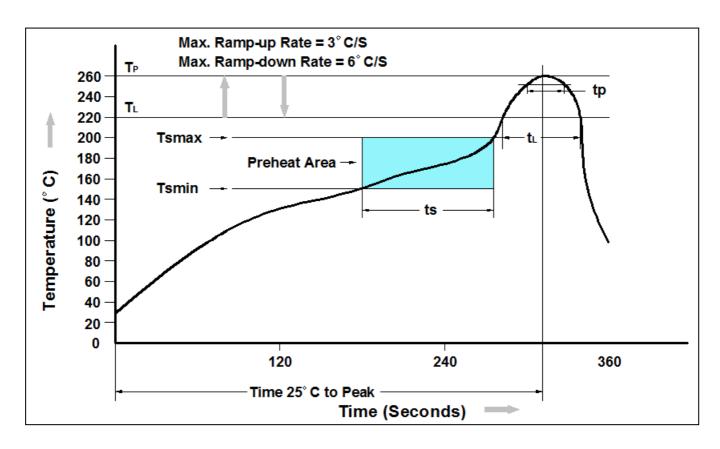


Fig.11 Unclamped Inductive Switching Waveform



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Recommand IR Reflow Soldering Thermal Profile



Profile Feature	Pb-Free Assembly Profile			
Temperature Min. (Tsmin)	150°C			
Temperature Max. (Tsmax)	200°C			
Time (ts) from (Tsmin to Tsmax)	60-120 seconds			
Average Ramp-up Rate (tLto tP)	3°C/second max.			
Liquidous Temperature (TL)	217°C			
Time (tL) Maintained Above (TL)	60 – 150 seconds			
Peak Temperature	260°C +0°C / -5°C			
Time (tP) within 5°C of actual Peak Temperature	30 seconds			
Ramp-down Rate (TP to TL)	6°C/second max			
Time 25°C to Peak Temperature	8 minutes max.			

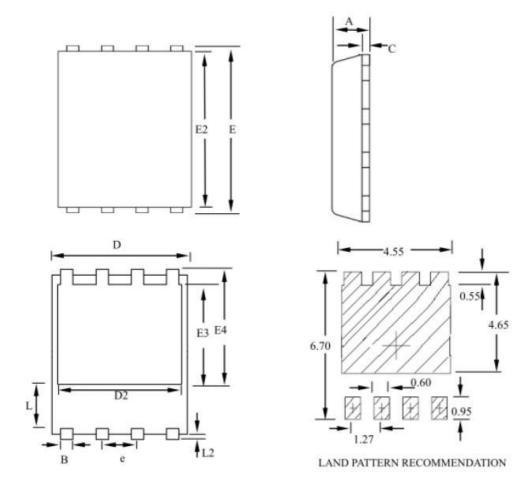
Ordering Information

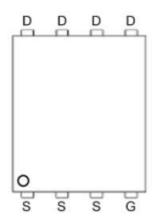
Part Number	Description	Quantity
PAN00SY48Y	DFN5X6A-EP1 Reel	3000 pcs



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Package Information (DFN5X6A-EP1)





SYMBOLS	MILLIMETERS			INCHES		
OTWIDOLO	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.80	177.	1.20	0.031		0.047
В	0.30		0.51	0.012		0.020
С	0.15	***	0.35	0.006		0.014
D	4.80		5.30	0.189		0.209
D2	3.61	7.5	4.35	0.142		0.171
Е	5.90		6.35	0.232		0.250
E2	5.42	44	5.90	0.213	T	0.232
E3	3.23		3.90	0.127		0.154
E4	3.69	(25)	4.55	0.145		0.179
L	0.61	**	1.80	0.024	**	0.071
L2	0.05		0.36	0.002		0.014
е		1.27			0.050	





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